

## **Dual General Purpose Transistor** NST3904DXV6T1G, NSVT3904DXV6T1G, NST3904DXV6T5G

The NST/NSV3904DXV6 device is a spin-off of our popular SOT-23/SOT-323 three-leaded device. It is designed for general purpose amplifier applications and is housed in the SOT-563 six-leaded surface mount package. By putting two discrete devices in one package, this device is ideal for low-power surface mount applications where board space is at a premium.

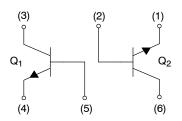
#### **Features**

- h<sub>FE</sub>, 100-300
- Low  $V_{CE(sat)}$ ,  $\leq 0.4 \text{ V}$
- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- AEC-Q101 Qualified and PPAP Capable NSVT3904DXV6T1G
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements

#### **MAXIMUM RATINGS**

Rating		Symbol	Value	Unit
Collector - Emitter Voltage		$V_{CEO}$	40	Vdc
Collector - Base Voltage		V <sub>CBO</sub>	60	Vdc
Emitter - Base Voltage		V <sub>EBO</sub>	6.0	Vdc
Collector Current - Continuous		I <sub>C</sub>	200	mAdc
Electrostatic Discharge	HBM MM	ESD	>16000 >2000	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



NST/NSV3904DXV6

## **MARKING** DIAGRAM



SOT-563 CASE 463A STYLE 1



MA = Device Code M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NST3904DXV6T1G	SOT-563 (Pb-Free)	4000/Tape & Reel
NSVT3904DXV6T1G	SOT-563 (Pb-Free)	4000/Tape & Reel
NST3904DXV6T5G	SOT-563 (Pb-Free)	8000/Tape & Reel
SNST3904DXV6T1G	SOT-563 (Pb-Free)	4000/Tape & Reel
SNST3904DXV6T5G	SOT-563 (Pb-Free)	8000/Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## THERMAL CHARACTERISTICS

Characteristic (One Junction Heated)	Symbol	Max	Unit
Total Device Dissipation T <sub>A</sub> = 25°C Derate above 25°C (Note 1)	P <sub>D</sub>	357 2.9	mW mW/°C
Thermal Resistance Junction-to-Ambient (Note 1)	$R_{ heta JA}$	350	°C/W
Characteristic (Both Junctions Heated)	Symbol	Max	Unit
Total Device Dissipation T <sub>A</sub> = 25°C Derate above 25°C (Note 1)	P <sub>D</sub>	500 4.0	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{ heta JA}$	250	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

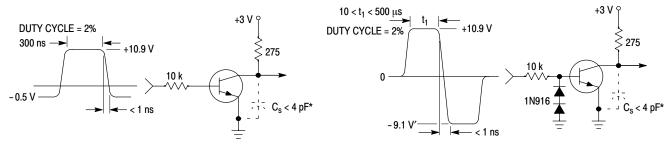
<sup>1.</sup> FR-4 @ Minimum Pad

### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

OFF CHARACTERISTICS		Characteristic	Symbol	Min	Max	Unit
Collector - Base Breakdown Voltage (I <sub>C</sub> = 10 μAdc, I <sub>E</sub> = 0)						
Collector - Base Breakdown Voltage (I <sub>C</sub> = 10 μAdc, I <sub>E</sub> = 0)	Collector - Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	40	_	Vdc	
Emitter - Base Breakdown Voltage (  <sub>E</sub> = 10 μAdc,   <sub>C</sub> = 0)	Collector - Base Breakdown Voltage (I		60	-	Vdc	
Collector Cutoff Current (V <sub>CE</sub> = 30 Vdc, V <sub>EB</sub> = 3.0 Vdc)	Emitter – Base Breakdown Voltage (I <sub>E</sub>	= 10 $\mu$ Adc, I <sub>C</sub> = 0)		6.0	-	Vdc
DC Current Gain   Nade, VoE = 1.0 Vdc   VoE   1.0 Vdc   (I <sub>C</sub> = 1.0 mAdc, VoE = 1.0 Vdc)   (I <sub>C</sub> = 1.0 mAdc, VoE = 1.0 Vdc)   (I <sub>C</sub> = 1.0 mAdc, VoE = 1.0 Vdc)   (I <sub>C</sub> = 1.0 mAdc, VoE = 1.0 Vdc)   (I <sub>C</sub> = 1.0 mAdc, VoE = 1.0 Vdc)   (I <sub>C</sub> = 50 mAdc, I <sub>E</sub> = 1.0 mAdc)   (I <sub>C</sub> = 50 mAdc, I <sub>E</sub> = 1.0 mAdc)   (I <sub>C</sub> = 50 mAdc, I <sub>E</sub> = 1.0 mAdc)   (I <sub>C</sub> = 50 mAdc, I <sub>E</sub> = 1.0 mAdc)   (I <sub>C</sub> = 50 mAdc, I <sub>E</sub> = 1.0 mAdc)   (I <sub>C</sub> = 50 mAdc, I <sub>E</sub> = 1.0 mAdc)   (I <sub>C</sub> = 50 mAdc, I <sub>E</sub> = 1.0 mAdc)   (I <sub>C</sub> = 50 mAdc, I <sub>E</sub> = 1.0 mAdc)   (I <sub>C</sub> = 50 mAdc, I <sub>E</sub> = 5.0 mAdc)   (I <sub>C</sub> = 10 mAdc, I <sub>E</sub> = 5.0 mAdc)   (I <sub>C</sub> = 50 mAdc, I <sub>E</sub> = 5.0 mAdc)   (I <sub>C</sub> = 10 mAdc, I <sub>E</sub> = 5.0 mAdc)   (I <sub>C</sub> = 50 mAdc, I <sub>E</sub> = 5.0 mAdc)   (I <sub>C</sub> = 10 mAdc, I <sub>E</sub> = 5.0 mAdc)   (I <sub>C</sub> = 10 mAdc, I <sub>E</sub> = 5.0 mAdc)   (I <sub>C</sub> = 10 mAdc, I <sub>E</sub> = 1.0 mAdc)   (I <sub>C</sub> = 10 mAdc, I <sub>E</sub> = 1.0 mAdc)   (I <sub>C</sub> = 10 mAdc, I <sub>E</sub> = 1.0 mAdc)   (I <sub>C</sub> = 10 mAdc, I <sub>E</sub> = 1.0 mAdc)   (I <sub>C</sub> = 10 mAdc, I <sub>E</sub> = 1.0 mAdc)   (I <sub>C</sub> = 1.0 mAdc, I <sub>E</sub> = 1.0 mAdc)   (I <sub>C</sub> = 1.0 mAdc, I <sub>E</sub> = 1.0 mAdc, I <sub>E</sub> = 1.0 mAdc)   (I <sub>C</sub> = 1.0 mAdc, I <sub>E</sub> = 1.0 mAdc, I <sub>E</sub> = 1.0 mAdc)   (I <sub>C</sub> = 1.0 mAdc, I <sub>E</sub> = 1.0	Base Cutoff Current (V <sub>CE</sub> = 30 Vdc, V <sub>I</sub>	<sub>EB</sub> = 3.0 Vdc)	I <sub>BL</sub>	_	50	nAdc
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Collector Cutoff Current (V <sub>CE</sub> = 30 Vdc	c, V <sub>EB</sub> = 3.0 Vdc)	I <sub>CEX</sub>	-	50	nAdc
	ON CHARACTERISTICS (Note 2)					
			h <sub>FE</sub>	70 100 60	- 300 - -	-
	$(I_C = 10 \text{ mAdc}, I_B = 1.0 \text{ mAdc})$		V <sub>CE(sat)</sub>	-		Vdc
	$(I_C = 10 \text{ mAdc}, I_B = 1.0 \text{ mAdc})$	V <sub>BE(sat)</sub>	0.65 -		Vdc	
Output Capacitance ( $V_{CB} = 5.0 \text{ Vdc}$ , $I_E = 0$ , $f = 1.0 \text{ MHz}$ ) $C_{obo}$ -         4.0         pF           Input Capacitance ( $V_{CB} = 0.5 \text{ Vdc}$ , $I_C = 0$ , $f = 1.0 \text{ MHz}$ ) $C_{ibo}$ -         8.0         pF           Input Impedance ( $V_{CE} = 10 \text{ Vdc}$ , $I_C = 1.0 \text{ mAdc}$ , $f = 1.0 \text{ kHz}$ ) $h_{ie}$ 1.0         10         k Ω           Voltage Feedback Ratio ( $V_{CE} = 10 \text{ Vdc}$ , $I_C = 1.0 \text{ mAdc}$ , $f = 1.0 \text{ kHz}$ ) $h_{re}$ 0.5         8.0         X 10 <sup>-4</sup> Small – Signal Current Gain ( $V_{CE} = 10 \text{ Vdc}$ , $I_C = 1.0 \text{ mAdc}$ , $f = 1.0 \text{ kHz}$ ) $h_{fe}$ 100         400         -           Output Admittance ( $V_{CE} = 10 \text{ Vdc}$ , $I_C = 1.0 \text{ mAdc}$ , $f = 1.0 \text{ kHz}$ ) $h_{oe}$ 1.0         40         μmhos           Noise Figure ( $V_{CE} = 5.0 \text{ Vdc}$ , $I_C = 100 \text{ μAdc}$ , $R_S = 1.0 \text{ k} \Omega$ , $f = 1.0 \text{ kHz}$ ) $NF$ -         5.0         dB           SWITCHING CHARACTERISTICS           Delay Time         ( $V_{CC} = 3.0 \text{ Vdc}$ , $V_{BE} = -0.5 \text{ Vdc}$ ) $V_C = 3.0 \text{ Vdc}$ , $V_C = 3.0  V$	SMALL-SIGNAL CHARACTERISTIC	S				
Input Capacitance (V <sub>EB</sub> = 0.5 Vdc, I <sub>C</sub> = 0, f = 1.0 MHz) $C_{ibo}$ -         8.0         pF           Input Impedance (V <sub>CE</sub> = 10 Vdc, I <sub>C</sub> = 1.0 mAdc, f = 1.0 kHz) $h_{ie}$ 1.0         10         k Ω           Voltage Feedback Ratio (V <sub>CE</sub> = 10 Vdc, I <sub>C</sub> = 1.0 mAdc, f = 1.0 kHz) $h_{re}$ 0.5         8.0         X 10 <sup>-4</sup> Small – Signal Current Gain (V <sub>CE</sub> = 10 Vdc, I <sub>C</sub> = 1.0 mAdc, f = 1.0 kHz) $h_{fe}$ 100         400         -           Output Admittance (V <sub>CE</sub> = 10 Vdc, I <sub>C</sub> = 1.0 mAdc, f = 1.0 kHz) $h_{oe}$ 1.0         40         µmhos           Noise Figure (V <sub>CE</sub> = 5.0 Vdc, I <sub>C</sub> = 100 µAdc, R <sub>S</sub> = 1.0 k Ω, f = 1.0 kHz)         NF         -         5.0         dB           SWITCHING CHARACTERISTICS           Delay Time         (V <sub>CC</sub> = 3.0 Vdc, V <sub>BE</sub> = -0.5 Vdc)         td         -         35         ns           Storage Time         (V <sub>CC</sub> = 3.0 Vdc, I <sub>C</sub> = 10 mAdc)         ts         -         200         ns	Current - Gain - Bandwidth Product (I	$_{C}$ = 10 mAdc, $V_{CE}$ = 20 Vdc, f = 100 MHz)	f <sub>T</sub>	300	-	MHz
	Output Capacitance (V <sub>CB</sub> = 5.0 Vdc, I <sub>E</sub>	C <sub>obo</sub>	_	4.0	pF	
Voltage Feedback Ratio ( $V_{CE} = 10 \text{ Vdc}$ , $I_{C} = 1.0 \text{ mAdc}$ , $f = 1.0 \text{ kHz}$ )	Input Capacitance (V <sub>EB</sub> = 0.5 Vdc, I <sub>C</sub> =	C <sub>ibo</sub>	_	8.0	pF	
Small – Signal Current Gain ( $V_{CE}$ = 10 Vdc, $I_{C}$ = 1.0 mAdc, $f$ = 1.0 kHz)	Input Impedance (V <sub>CE</sub> = 10 Vdc, I <sub>C</sub> = 1	h <sub>ie</sub>			kΩ	
Output Admittance (V <sub>CE</sub> = 10 Vdc, I <sub>C</sub> = 1.0 mAdc, f = 1.0 kHz)       h <sub>oe</sub> 1.0 do	Voltage Feedback Ratio (V <sub>CE</sub> = 10 Vde	h <sub>re</sub>			X 10 <sup>-4</sup>	
Noise Figure ( $V_{CE} = 5.0 \text{ Vdc}$ , $I_C = 100 \text{ μAdc}$ , $R_S = 1.0 \text{ k} \Omega$ , $f = 1.0 \text{ kHz}$ )   NF   $-$   5.0   dB	Small – Signal Current Gain (V <sub>CE</sub> = 10	h <sub>fe</sub>			-	
	Output Admittance (V <sub>CE</sub> = 10 Vdc, I <sub>C</sub> =	h <sub>oe</sub>			μmhos	
	Noise Figure (V <sub>CE</sub> = 5.0 Vdc, I <sub>C</sub> = 100 $\mu$ Adc, R <sub>S</sub> = 1.0 k $\Omega$ , f = 1.0 kHz)		NF	- -		dB
Rise Time	SWITCHING CHARACTERISTICS					•
Rise Time	Delay Time	(V <sub>CC</sub> = 3.0 Vdc, V <sub>BE</sub> = -0.5 Vdc)	t <sub>d</sub>	_	35	
ns	Rise Time	(I <sub>C</sub> = 10 mAdc, I <sub>B1</sub> = 1.0 mAdc)	t <sub>r</sub>	_	35	ns
	Storage Time	(V <sub>CC</sub> = 3.0 Vdc, I <sub>C</sub> = 10 mAdc)	t <sub>s</sub>	_	ns	
	Fall Time	$(I_{B1} = I_{B2} = 1.0 \text{ mAdc})$	t <sub>f</sub>	_		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Pulse Test: Pulse Width  $\leq$  300 µs; Duty Cycle  $\leq$  2.0%.



\* Total shunt capacitance of test jig and connectors

Figure 1. Delay and Rise Time Equivalent Test Circuit

Figure 2. Storage and Fall Time Equivalent Test Circuit

#### **TYPICAL TRANSIENT CHARACTERISTICS**

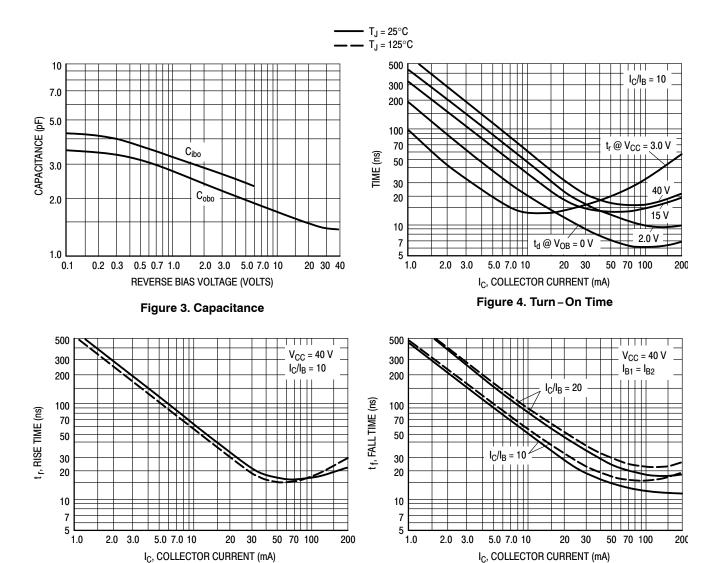
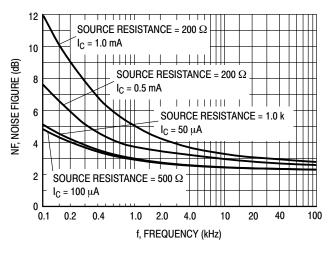


Figure 5. Rise Time

Figure 6. Fall Time

# TYPICAL AUDIO SMALL-SIGNAL CHARACTERISTICS NOISE FIGURE VARIATIONS

 $(V_{CE} = 5.0 \text{ Vdc}, T_A = 25^{\circ}\text{C}, Bandwidth = 1.0 \text{ Hz})$ 



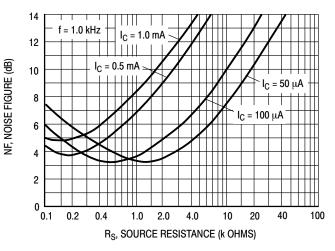
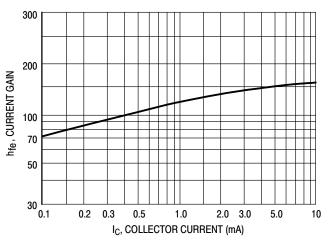


Figure 7. Noise Figure

Figure 8. Noise Figure

#### **h PARAMETERS**

 $(V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz}, T_A = 25^{\circ}\text{C})$ 



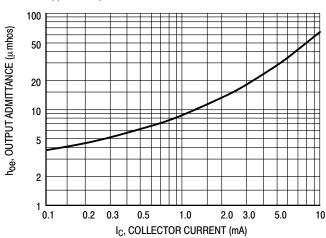


Figure 9. Current Gain

Figure 10. Output Admittance

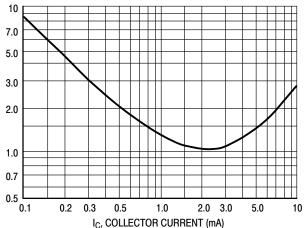


Figure 11. Input Impedance

Figure 12. Voltage Feedback Ratio

, VOLTAGE FEEDBACK RATIO (x 10 -4)

### **TYPICAL STATIC CHARACTERISTICS**

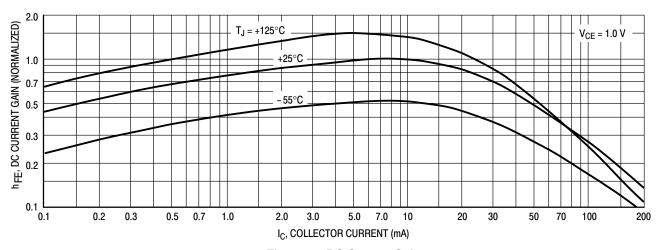


Figure 13. DC Current Gain

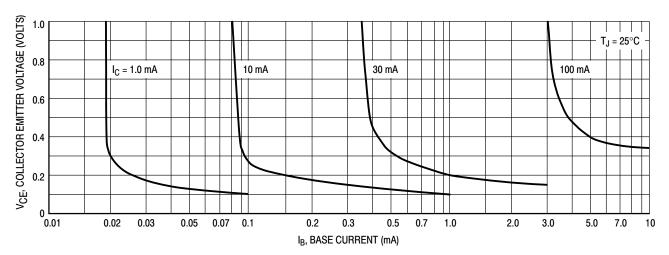


Figure 14. Collector Saturation Region

#### **TYPICAL STATIC CHARACTERISTICS**

1.2

 $I_{\rm C}/I_{\rm B}=10$ 

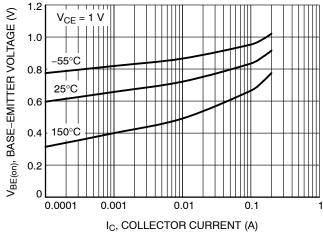
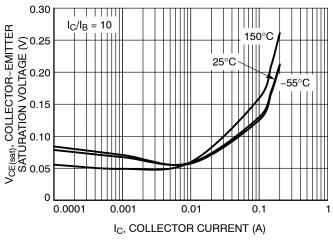


Figure 15. Base Emitter Voltage vs. Collector Current

Figure 16. Base Emitter Saturation Voltage vs.
Collector Current



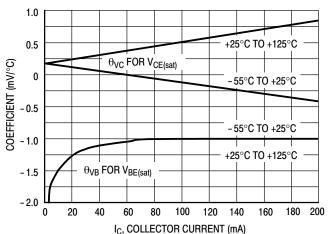


Figure 17. Collector Emitter Saturation Voltage vs. Collector Current

Figure 18. Temperature Coefficients

## MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS



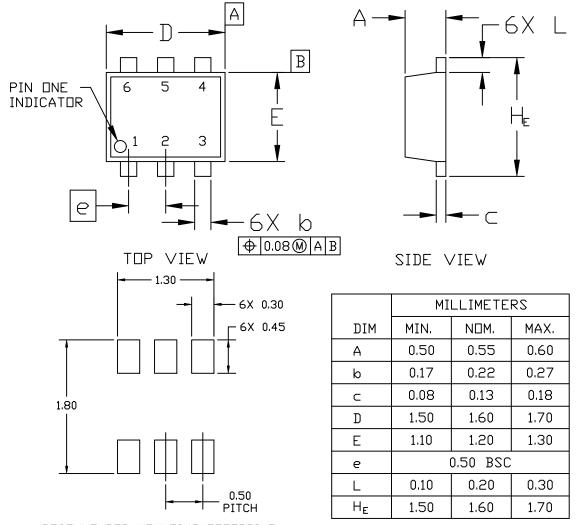


#### SOT-563, 6 LEAD CASE 463A ISSUE H

**DATE 26 JAN 2021** 

#### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.



#### RECOMMENDED MOUNTING FOOTPRINT\*

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

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#### **SOT-563, 6 LEAD**

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**DATE 26 JAN 2021** 

STYLE 1: PIN 1. EMITTER 1 2. BASE 1 3. COLLECTOR 2 4. EMITTER 2 5. BASE 2 6. COLLECTOR 1	STYLE 2: PIN 1. EMITTER 1 2. EMITTER 2 3. BASE 2 4. COLLECTOR 2 5. BASE 1 6. COLLECTOR 1	STYLE 3: PIN 1. CATHODE 1 2. CATHODE 1 3. ANODE/ANODE 4. CATHODE 2 5. CATHODE 2 6. ANODE/ANODE
STYLE 4: PIN 1. COLLECTOR 2. COLLECTOR 3. BASE 4. EMITTER 5. COLLECTOR 6. COLLECTOR	STYLE 5: PIN 1. CATHODE 2. CATHODE 3. ANODE 4. ANODE 5. CATHODE 6. CATHODE	STYLE 6: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE
STYLE 7: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. ANODE 6. CATHODE	STYLE 8: PIN 1. DRAIN 2. DRAIN 3. GATE 4. SDURCE 5. DRAIN 6. DRAIN	STYLE 9: PIN 1. SDURCE 1 2. GATE 1 3. DRAIN 2 4. SDURCE 2 5. GATE 2 6. DRAIN 1
STYLE 10: PIN 1. CATHODE 1 2. N/C 3. CATHODE 2 4. ANODE 2 5. N/C 6. ANODE 1	STYLE 11: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	

## GENERIC MARKING DIAGRAM\*



XX = Specific Device CodeM = Month Code= Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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